

PTC thermistors

Series/Type: T1550, T1509, T1735, T1535

The following products presented in this data sheet are being withdrawn.

| Ordering Code | Substitute Product | Date of Withdrawal | Deadline Last Orders | Last Shipments |
|-----------------|--------------------|-----------------------|-------------------------|-------------------|
| B59735T1150A062 | | 2019-03-01 | 2019-06-07 | 2019-09-07 |
| B59550T1120A262 | | 2019-03-01 | 2019-06-07 | 2019-09-07 |
| B59550T1120A062 | | 2019-03-01 | 2019-06-07 | 2019-09-07 |



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| B59535T1120A262 | | 2019-03-01 | 2019-06-07 | 2019-09-07 |
| B59535T1120A062 | | 2019-03-01 | 2019-06-07 | 2019-09-07 |
| B59509T1120A062 | | 2019-03-01 | 2019-06-07 | 2019-09-07 |

Please contact your nearest TDK sales office if you need support in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.tdk-electronics.tdk.com/sales.



Telecom pair protector (TPP), SMD

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Applications

- Overcurrent protection for telecom applications
- Suitable for line card applications e.g. POTS, access networks, customer premises equipment (CPE) or integrated voice data (IVD)

Internal circuit



Features

- Two resistance-matched PTCs in a plastic housing
- Compliant with ITU-T standards
 - basic-level lightning surges (10/700 μs)
 - basic-level power induction (600 V, 1 A, 0.2 s)
 - power contact criteria A/B (230 V, 15 min.)
- Compliant with GR-1089 AC power contact 120 V, 25 A, 15 min.
- Suitable for continuous connection to mains voltages of 110/230 V AC in tripped (high-ohmic) condition
- Housing material to UL94-V0
- UL approval to UL 1434 (file number E69802) for selected types
- Tight resistance matching maintained after switching
- Negligible resistance drift after reflow soldering or switching
- Marked with manufacturer's logo, type designation and date code
- RoHS-compatible

Options

Alternative tolerances and resistances on request

Delivery mode

- T15** and T16**: Blister tape, 330-mm reel with 16-mm tape, taping to IEC 60286-3
- T17** and T18**: Blister tape, 380-mm reel with 24-mm tape, taping to IEC 60286-3

General technical data

| Maximum fault voltage ¹⁾ | | $V_{F,max}$ | 245 | V AC |
|---|------------------|-----------------|----------|------|
| Max. operating voltage | | V_{max} | 135 | V AC |
| Operating temperature range | (V = 0) | T _{op} | -20/+125 | °C |
| Operating temperature range | $(V = V_{max})$ | T _{op} | 0/+70 | °C |
| Insulating test voltage between PTC1 and PTC2 | V _{ins} | > 3 | kV | |
| Resistance matching in one housing | | $ R_2 - R_1 $ | < 1.0 | Ω |

¹⁾ The maximum fault voltage V_{F,max} is the highest voltage that is permitted to be applied across the PTC thermistor in protection mode.



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Electrical specifications and ordering codes

| Туре | R_R | ΔR_R | I _R | I _R | Is | I _{Smax} | Approvals | Ordering code |
|-------|----------------------------|---------------|----------------|----------------|---------|-------------------|-------------|-----------------|
| | | | @ 25 °C | @ 70 °C | @ 25 °C | | | |
| | Ω | % | mA | mA | mA | Α | <i>5</i> /1 | |
| Compo | nent he | eight max. 7. | .3 | | | | | |
| T1535 | 35 | +15/-20 | 100 | 65 | 210 | 2.5 | _ | B59535T1120A262 |
| T1550 | 50 | ±15 | 80 | 50 | 170 | 2.5 | _ | B59550T1120A262 |
| Compo | nent he | eight max. 8 | .3 | | | | | |
| T1509 | 9 | ±10 | 180 | 120 | 360 | 1.0 | _ | B59509T1120A062 |
| T1535 | 35 | +15/-20 | 110 | 70 | 230 | 4.6 | _ | B59535T1120A062 |
| T1550 | 50 | ±15 | 90 | 60 | 190 | 2.5 | _ | B59550T1120A062 |
| Compo | nent he | eight max. 9 | .9 | | | | | |
| T1635 | 35 | +15/-20 | 110 | 70 | 230 | 4.6 | Х | B59635T1120A062 |
| T1650 | 50 | ±15 | 90 | 60 | 190 | 2.5 | X | B59650T1120A062 |
| Compo | nent he | eight max. 1 | 0.5 | | | | | |
| T1735 | 35 | +15/-20 | 110 | 70 | 230 | 4.6 | X | B59735T1120A062 |
| T1735 | 35 | +15/-20 | 130 | 95 | 270 | 3.6 | _ | B59735T1150A062 |
| T1750 | 50 | ±15 | 90 | 60 | 190 | 2.5 | X | B59750T1120A062 |
| Compo | Component height max. 11.5 | | | | | | | |
| T1835 | 35 | +15/-20 | 115 | 75 | 240 | 4.6 | Χ | B59835T1120A062 |

Switching times and ordering codes

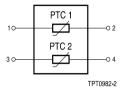
| | I | T | I | _ | | |
|---------------------------|----------------------------|-----------------------|-----------------------|-----------------|--|--|
| Type | t _S (typ.) | t _S (typ.) | t _S (typ.) | Ordering code | | |
| | @ I _{Smax} | @ 1 A | @ 500 mA | | | |
| | s | s | s | | | |
| Component height max. 7.3 | | | | | | |
| T1535 | 0.07 | 0.4 | 1.7 | B59535T1120A262 | | |
| T1550 | 0.05 | 0.3 | 1.2 | B59550T1120A262 | | |
| Component height max. 8.3 | | | | | | |
| T1509 | 4 | 4 | 20 | B59509T1120A062 | | |
| T1535 | 0.04 | 0.8 | 3.4 | B59535T1120A062 | | |
| T1550 | 0.1 | 0.6 | 2.4 | B59550T1120A062 | | |
| Compone | nt height max. | 9.9 | | | | |
| T1635 | 0.04 | 0.8 | 3.4 | B59635T1120A062 | | |
| T1650 | 0.1 | 0.6 | 2.4 | B59650T1120A062 | | |
| Compone | nt height max. | 10.5 | | | | |
| T1735 | 0.04 | 0.8 | 3.4 | B59735T1120A062 | | |
| T1735 | 0.1 | 1.1 | 4.5 | B59735T1150A062 | | |
| T1750 | 0.1 | 0.6 | 2.4 | B59750T1120A062 | | |
| Compone | Component height max. 11.5 | | | | | |
| T1835 | 0.06 | 1.1 | 4.5 | B59835T1120A062 | | |
| 1 1033 | 0.00 | 1.1 | 4.5 | D0900011120A002 | | |



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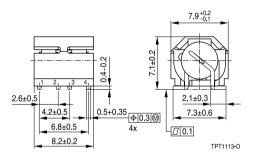
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Internal circuit

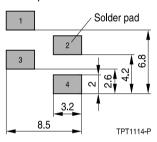


Dimensional drawings in mm

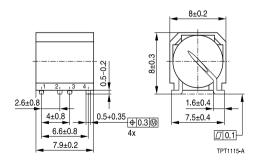
Maximum component height 7.3 mm



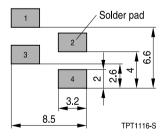
Solder pad



Maximum component height 8.3 mm



Solder pad



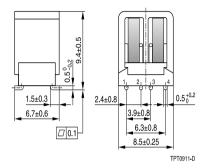


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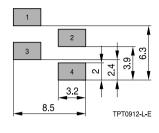
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Dimensional drawings in mm

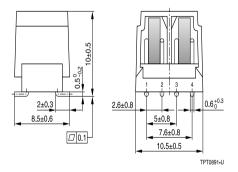
Maximum component height 9.9 mm



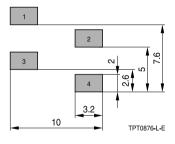
Solder pad



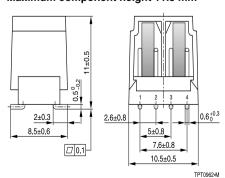
Maximum component height 10.5 mm



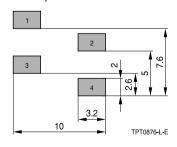
Solder pad



Maximum component height 11.5 mm



Solder pad





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Reliability data

| Test | Standard | Test conditions | $ \Delta R_{25}/R_{25} $ |
|-----------------------|-------------|---|--------------------------|
| Electrical endurance, | IEC 60738-1 | Room temperature, I _{Smax} ; V _{max} | < 20% |
| cycling | | Number of cycles: 10 | |
| Electrical endurance, | IEC 60738-1 | Storage at V _{max} and T _{op,max} (@ V _{max}) | < 25% |
| constant | | Test duration: 1000 h | |
| Damp heat | IEC 60738-1 | Temperature of air: 40 °C | < 10% |
| | | Relative humidity of air: 93% | |
| | | Duration: 56 days | |
| | | Test according to IEC 60068-2-78 | |
| Rapid change | IEC 60738-1 | $T_1 = T_{op,min} (0 \text{ V}), T_2 = T_{op,max} (0 \text{ V})$ | < 10% |
| of temperature | | Number of cycles: 5 | |
| | | Test duration: 30 min | |
| | | Test according to IEC 60068-2-14, test Na | |
| Vibration | IEC 60738-1 | Frequency range: 10 to 55 Hz | < 5% |
| | | Displacement amplitude: 0.75 mm | |
| | | Test duration: 3 × 2 h | |
| | | Test according to IEC 60068-2-6, test Fc | |
| Shock | IEC 60738-1 | Acceleration: 400 m/s ² | < 5% |
| | | Pulse duration: 6 ms; 6 × 5000 pulses | |
| Climatic sequence | IEC 60738-1 | Dry heat: $T = T_{op,max}(0 \text{ V})$ | < 10% |
| | | Test duration: 16 h | |
| | | Damp heat first cycle | |
| | | Cold: $T = T_{op,min}(0 \text{ V})$ | |
| | | Test duration: 2 h | |
| | | Damp heat 5 cycles | |
| | | Tests performed according to | |
| | | IEC 60068-2-30 | |



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ITU performance overview and fault conditions

| | Test no. | ITU K20 | | ITU K21 | | ITU K45 | |
|-----------------|----------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| | | Basic test level | Enhanced test level | Basic test level | Enhanced test level | Basic test level | Enhanced test level |
| Power induction | 1 | Α | Α | Α | Α | Α | Α |
| | 2 | В | С | В | С | В | С |
| Power contact | 3 | D | E | D | E | D | E |
| Lightning surge | 4 | F | G | G | G | G | G |
| | 5 | Н | Н | Н | I | Н | Н |

| Power induction | Α | 600 V AC, R = 600 Ω, t = 0.2 s, criteria A |
|-----------------|---|---|
| | В | 600 V AC, R = 600 Ω , t = 1.0 s, with GDT, criteria A |
| | С | 1500 V AC, R = 200 Ω , t = 2.0 s, with GDT, criteria A |
| Power contact | D | 230 V AC, t = 15 min, R = 10 1000 Ω, criteria B |
| | Е | 230 V AC, t = 15 min, R = 10, 20, 40, 80, 1000 Ω , criteria B, R = 160, 300, 600 Ω , criteria A |
| Lightning surge | F | $V_{c(max)}$ = 1.0 kV, R = 25 Ω , t = 10/700 μ s, without GDT, criteria A |
| | G | $V_{c(max)} = 1.5$ kV, R = 25 Ω , t = 10/700 μ s, without GDT, criteria A |
| | Н | $V_{c(max)} = 4.0$ kV, R = 25 Ω , t = 10/700 μ s, with GDT, criteria A |
| | Ι | $V_{c(max)} = 6.0$ kV, R = 25 Ω , t = 10/700 μ s, with GDT, criteria A |

Note: Use a GDT (gas discharge tube) with adequate electrical properties in order to ensure reliable operation at enhanced test levels (power induction, lightning surge).

Criteria A: no damage, function must be fulfilled.

Criteria B: no fire hazard.

Electrical requirements according to GR-1089 standard for AC power contact

AC voltage: 120 V, 50 Hz, short circuit current 25 A, time 15 min, criteria A.



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 1210 and smaller: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- The ceramic and metallization of the components must not be touched with bare hands. Gloves are recommended
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force and pressure of the clamping contacts pressing against the PTC must be 10 N and 50 kPa, respectively. In case the assembly is exposed to mechanical shock and/ or vibration this force should be higher in order to avoid movement of the PTC during operation.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

Display of ordering codes for EPCOS products

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Symbols and terms

| Symbol | Term |
|-----------------------|--|
| A | Area |
| С | Capacitance |
| C_{th} | Heat capacity |
| f | Frequency |
| 1 | Current |
| I _{max} | Maximum current |
| I _R | Rated current |
| I _{res} | Residual current |
| I _{PTC} | PTC current |
| I_r | Residual currrent |
| $I_{r,oil}$ | Residual currrent in oil (for level sensors) |
| $I_{r,air}$ | Residual currrent in air (for level sensors) |
| I _{RMS} | Root-mean-square value of current |
| Is | Switching current |
| I _{Smax} | Maximum switching current |
| LCT | Lower category temperature |
| N | Number (integer) |
| N_c | Operating cycles at V _{max} , charging of capacitor |
| N_f | Switching cycles at V _{max} , failure mode |
| Р | Power |
| P ₂₅ | Maximum power at 25 °C |
| P_{el} | Electrical power |
| P_{diss} | Dissipation power |
| R_G | Generator internal resistance |
| R_{min} | Minimum resistance |
| R_R | Rated resistance @ rated temperature T _R |
| ΔR_R | Tolerance of R _R |
| R_P | Parallel resistance |
| R_{PTC} | PTC resistance |
| R_{ref} | Reference resistance |
| R_S | Series resistance |
| R ₂₅ | Resistance at 25 °C |
| R _{25,match} | Resistance matching per reel/ packing unit at 25 °C |
| ΔR_{25} | Tolerance of R ₂₅ |



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| Т | Temperature |
|-------|----------------------------|
| t | Time |
| T_A | Ambient temperature |
| ta | Thermal threshold time |
| _ | Causa ala atria Conia tana |

 $\begin{array}{ll} T_{\text{C}} & \text{Ferroelectric Curie temperature} \\ t_{\text{E}} & \text{Settling time (for level sensors)} \end{array}$

T_B Rated temperature @ 25 °C or otherwise specified in the data sheet

 $\begin{array}{ll} T_{\text{sense}} & & \text{Sensing temperature} \\ T_{\text{op}} & & \text{Operating temperature} \\ T_{\text{PTC}} & & \text{PTC temperature} \\ t_{\text{R}} & & \text{Response time} \end{array}$

T_{ref} Reference temperature

T_{Bmin} Temperature at minimum resistance

t_S Switching time T_{surf} Surface temperature

UCT Upper category temperature

V or V_{el} Voltage (with subscript only for distinction from volume)
V_{c(max)} Maximum DC charge voltage of the surge generator

V_{E max} Maximum voltage applied at fault conditions in protection mode

V_{RMS} Root-mean-square value of voltage

 $\begin{array}{lll} V_{\text{BD}} & & \text{Breakdown voltage} \\ V_{\text{ins}} & & \text{Insulation test voltage} \\ V_{\text{link,max}} & & \text{Maximum link voltage} \\ V_{\text{max}} & & \text{Maximum operating voltage} \end{array}$

V_{max.dvn} Maximum dynamic (short-time) operating voltage

V_{meas} Measuring voltage

V_{meas,max} Maximum measuring voltage

V_R Rated voltage

V_{PTC} Voltage drop across a PTC thermistor

 $\begin{array}{lll} \alpha & & \text{Temperature coefficient} \\ \Delta & & \text{Tolerance, change} \\ \delta_{\text{th}} & & \text{Dissipation factor} \end{array}$

 τ_{th} Thermal cooling time constant

λ Failure rate

Lead spacing (in mm)



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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Important notes

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- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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